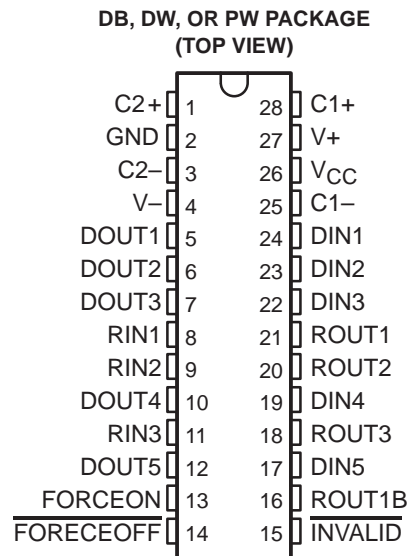


- Meet or Exceed the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operate With 3-V to 5.5-V  $V_{CC}$  Supply
- Always-Active Noninverting Receiver Output (ROUT1B)
- Designed to Operate up to 512 kbit/s
- Low Standby Current . . . 1  $\mu$ A Typical
- External Capacitors . . .  $4 \times 0.1 \mu$ F
- Accept 5-V Logic Input With 3.3-V Supply
- Designed to be Interchangeable With Maxim MAX3238C and MAX3238E
- RS-232 Bus-Pin ESD Protection Exceeds  $\pm 15$ -kV Using Human Body Model (HBM)
- Applications
  - Battery-Powered Systems, PDAs, Notebooks, Subnotebooks, Laptops, Palmtop PCs, Hand-Held Equipment, Modems, and Printers
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages



## description

The MAX3238 devices consist of five line drivers, three line receivers, and a dual charge-pump circuit with  $\pm 15$ -kV ESD protection pin-to-pin (serial-port connection pins, including GND). These devices provide the electrical interface between notebook and subnotebook computer applications and meet the requirements of TIA/EIA-232-F. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. In addition, these devices include an always-active noninverting output (ROUT1B), which allows applications using the ring indicator to transmit data while the device is powered down. These devices are designed to operate at data signaling rates up to 512 kbit/s, and a maximum of 30-V/ $\mu$ s driver output slew rate.

Flexible control options for power management are available when the serial port is inactive. The auto-powerdown feature functions when FORCEON is low and  $\overline{\text{FORCEOFF}}$  is high. During this mode of operation, if the devices do not sense a valid RS-232 signal, the driver outputs are disabled. If  $\overline{\text{FORCEOFF}}$  is set low, both drivers and receivers (except ROUT1B) are shut off, and the supply current is reduced to 1  $\mu$ A. Disconnecting the serial port or turning off the peripheral drivers causes the auto-powerdown condition to occur. Auto-powerdown can be disabled when FORCEON and  $\overline{\text{FORCEOFF}}$  are high. With auto-powerdown enabled, the devices are activated automatically when a valid signal is applied to any receiver input. The  $\overline{\text{INVALID}}$  output is used to notify the user if an RS-232 signal is present at any receiver input.  $\overline{\text{INVALID}}$  is high (valid data) if any receiver input voltage is greater than 2.7 V or less than -2.7 V or has been between -0.3 V and 0.3 V for less than 30  $\mu$ s.  $\overline{\text{INVALID}}$  is low (invalid data) if any receiver input voltage is between -0.3 V and 0.3 V for more than 30  $\mu$ s. Refer to Figure 4 for receiver input levels.

The MAX3238C is characterized for operation over the temperature range of 0°C to 70°C. The MAX3238I is characterized for operation over the temperature range of -40°C to 85°C.



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PRODUCT PREVIEW

**MAX3238**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER**

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**Function Tables**

**EACH DRIVER**

INPUTS				OUTPUT DOUT	DRIVER STATUS
DIN	FORCEON	FORCEOFF	VALID RIN RS-232 LEVEL		
X	X	L	X	Z	Powered off
L	H	H	X	H	Normal operation with auto-powerdown disabled
H	H	H	X	L	
L	L	H	Yes	H	Normal operation with auto-powerdown enabled
H	L	H	Yes	L	
L	L	H	No	Z	Powered off by auto-powerdown feature
H	L	H	No	Z	

H = high level, L = low level, X = irrelevant, Z = high impedance

**EACH RECEIVER**

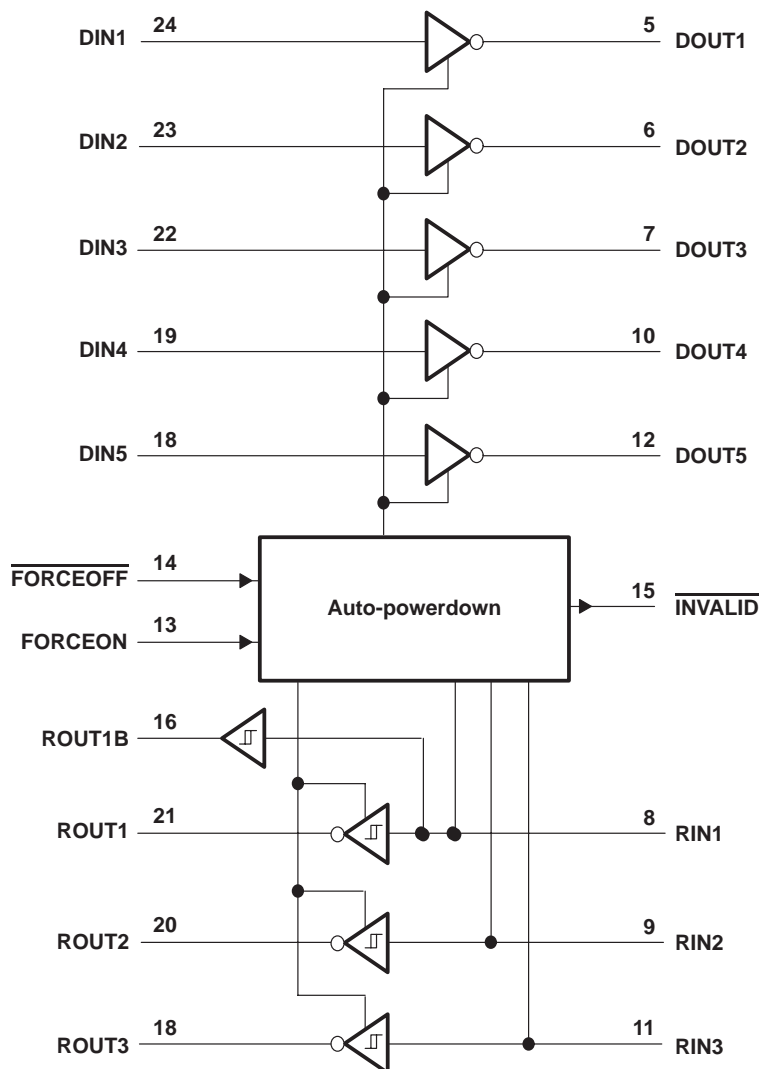
INPUTS				OUTPUTS		RECEIVER STATUS
RIN2	RIN1, RIN3–RIN5	FORCEOFF	VALID RIN RS-232 LEVEL	ROUT1B	ROUT	
L	X	L	X	L	Z	Powered off while ROUT1B is active
H	X	L	X	H	Z	
L	L	H	Yes	L	H	Normal operation with auto-powerdown disabled/enabled
L	H	H	Yes	L	L	
H	L	H	Yes	H	H	
H	H	H	Yes	H	L	
Open	Open	H	No	L	H	

H = high level, L = low level, X = irrelevant, Z = high impedance (off), Open = input disconnected or connected driver off

**PRODUCT PREVIEW**



logic diagram (positive logic)



PRODUCT PREVIEW

# MAX3238

## 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, $V_{CC}$ (see Note 1)	–0.3 V to 6 V
Positive output supply voltage, $V+$ (see Note 1)	–0.3 V to 7 V
Negative output supply voltage, $V-$ (see Note 1)	0.3 V to –7 V
Supply voltage difference, $V+ - V-$ (see Note 1)	13 V
Input voltage range, $V_I$ : Driver (FORCEOFF, FORCEON)	–0.3 V to 6 V
Receiver	–25 V to 25 V
Output voltage range, $V_O$ : Driver	–13.2 V to 13.2 V
Receiver (INVALID)	–0.3 V to $V_{CC} + 0.3$ V
Package thermal impedance, $\theta_{JA}$ (see Note 2): DB package	TBD°C/W
DW package	78°C/W
PW package	TBD°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, $T_{stg}$	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages are with respect to network GND.  
2. The package thermal impedance is calculated in accordance with JESD 51.

### recommended operating conditions (see Note 3 and Figure 5)

		MIN	NOM	MAX	UNIT
Supply voltage	$V_{CC} = 3.3$ V	3	3.3	3.6	V
	$V_{CC} = 5$ V	4.5	5	5.5	V
Driver and control high-level input voltage, $V_{IH}$	DIN, FORCEOFF, FORCEON	$V_{CC} = 3.3$ V	2		V
		$V_{CC} = 5$ V	2.4		
Driver and control low-level input voltage, $V_{IL}$	DIN, FORCEOFF, FORCEON			0.8	V
Receiver input voltage, $V_I$		–25		25	V
Operating free-air temperature, $T_A$	MAX3238C	0		70	°C
	MAX3238I	–40		85	

NOTE 3: Test conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at  $V_{CC} = 5$  V  $\pm$  0.5 V.

### electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 3 and Figure 5)

PARAMETER		TEST CONDITIONS	MIN	TYP‡	MAX	UNIT
$I_I$	Input leakage current	FORCEOFF, FORCEON		$\pm 0.01$	$\pm 1$	$\mu$ A
$I_{CC}$	Supply current	Auto-powerdown disabled	No load, FORCEOFF and FORCEON at $V_{CC}$	0.3	1	mA
		Powered off	No load, FORCEOFF at GND	1	10	
		Auto-powerdown enabled	No load, FORCEOFF at $V_{CC}$ , FORCEON at GND, All RIN are open or grounded	1	10	$\mu$ A

‡ All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V and  $T_A = 25^\circ$ C.

NOTE 3: Test conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at  $V_{CC} = 5$  V  $\pm$  0.5 V.

PRODUCT PREVIEW



### DRIVER SECTION

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 3 and Figure 5)**

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V <sub>OH</sub> High-level output voltage	All DOUT at R <sub>L</sub> = 3 kΩ to GND	5	5.4		V
V <sub>OL</sub> Low-level output voltage	All DOUT at R <sub>L</sub> = 3 kΩ to GND	-5	-5.4		V
I <sub>IH</sub> High-level input current	V <sub>I</sub> = V <sub>CC</sub>		±0.01	±1	μA
I <sub>IL</sub> Low-level input current	V <sub>I</sub> at GND		±0.01	±1	μA
I <sub>OS</sub> Short-circuit output current‡	V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 0 V		±35	±60	mA
	V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0 V				
r <sub>o</sub> Output resistance	V <sub>CC</sub> , V <sub>+</sub> , and V <sub>-</sub> = 0 V, V <sub>O</sub> = ±2 V	300	10M		Ω
I <sub>off</sub> Output leakage current	<u>FORCEOFF</u> = GND, V <sub>O</sub> = ±12 V, V <sub>CC</sub> = 0 to 5.5 V			±25	μA

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V and T<sub>A</sub> = 25°C.

‡ Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

NOTE 3. Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 3 and Figure 5)**

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
Maximum data rate	C <sub>L</sub> = 1000 pF, R <sub>L</sub> = 3 kΩ, One DOUT switching, See Figure 1	512			kbit/s
t <sub>sk(p)</sub> Pulse skew§	C <sub>L</sub> = 150 pF to 2500 pF, R <sub>L</sub> = 3 kΩ to 7 kΩ		100		ns
SR(tr) Slew rate, transition region (see Figure 1)	V <sub>CC</sub> = 3.3 V, R <sub>L</sub> = 3 kΩ to 7 kΩ	C <sub>L</sub> = 150 pF to 1000 pF	6	30	V/μs
		C <sub>L</sub> = 150 pF to 2500 pF	4	30	

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V and T<sub>A</sub> = 25°C.

§ Pulse skew is defined as |t<sub>PLH</sub> - t<sub>PHL</sub>|.

NOTE 3. Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

# MAX3238

## 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER

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### RECEIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 3 and Figure 5)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V <sub>OH</sub>	High-level output voltage	I <sub>OH</sub> = -1 mA	V <sub>CC</sub> - 0.6 V	V <sub>CC</sub> - 0.1 V		V
V <sub>OL</sub>	Low-level output voltage	I <sub>OL</sub> = 1.6 mA			0.4	V
V <sub>IT+</sub>	Positive-going input threshold voltage	V <sub>CC</sub> = 3.3 V		1.6	2.4	V
		V <sub>CC</sub> = 5 V		1.9	2.4	
V <sub>IT-</sub>	Negative-going input threshold voltage	V <sub>CC</sub> = 3.3 V	0.6	1.1		V
		V <sub>CC</sub> = 5 V	0.8	1.4		
V <sub>hys</sub>	Input hysteresis (V <sub>IT+</sub> - V <sub>IT-</sub> )			0.5		V
I <sub>off</sub>	Output leakage current (except ROUT1B)	FORCEOFF = 0 V		±0.05	±10	µA
r <sub>i</sub>	Input resistance	V <sub>I</sub> = ±3 V to ±25 V	3	5	7	kΩ

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V and T<sub>A</sub> = 25°C.

NOTE 3. Test conditions are C1-C4 = 0.1 µF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 µF, C2-C4 = 0.33 µF at V<sub>CC</sub> = 5 V ± 0.5 V.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 3)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t <sub>PLH</sub>	Propagation delay time, low- to high-level output	C <sub>L</sub> = 150 pF, See Figure 2		150		ns
t <sub>PHL</sub>	Propagation delay time, high- to low-level output			150		ns
t <sub>en</sub>	Output enable time	C <sub>L</sub> = 150 pF, R <sub>L</sub> = 3 kΩ, See Figure 3		200		ns
t <sub>dis</sub>	Output disable time			200		ns
t <sub>sk(p)</sub>	Pulse skew‡	See Figure 2		50		ns

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V and T<sub>A</sub> = 25°C.

‡ Pulse skew is defined as |t<sub>PLH</sub> - t<sub>PHL</sub>|.

NOTE 3. Test conditions are C1-C4 = 0.1 µF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 µF, C2-C4 = 0.33 µF at V<sub>CC</sub> = 5 V ± 0.5 V.

PRODUCT PREVIEW



**AUTO-POWERDOWN SECTION**

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 4)**

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
$V_{T+}$ (VALID)	Receiver input threshold for $\overline{\text{INVALID}}$ high-level output voltage	$\overline{\text{FORCEON}} = \text{GND},$ $\overline{\text{FORCEOFF}} = V_{\text{CC}}$			2.7	V
$V_{T-}$ (VALID)	Receiver input threshold for $\overline{\text{INVALID}}$ high-level output voltage	$\overline{\text{FORCEON}} = \text{GND},$ $\overline{\text{FORCEOFF}} = V_{\text{CC}}$	-2.7			V
$V_{T}$ (INVALID)	Receiver input threshold for $\overline{\text{INVALID}}$ low-level output voltage	$\overline{\text{FORCEON}} = \text{GND},$ $\overline{\text{FORCEOFF}} = V_{\text{CC}}$	-0.3		0.3	V
$V_{\text{OH}}$	$\overline{\text{INVALID}}$ high-level output voltage	$I_{\text{OH}} = -1 \text{ mA},$ $\overline{\text{FORCEON}} = \text{GND},$ $\overline{\text{FORCEOFF}} = V_{\text{CC}}$	$V_{\text{CC}} - 0.6$			V
$V_{\text{OL}}$	$\overline{\text{INVALID}}$ low-level output voltage	$I_{\text{OL}} = 1.6 \text{ mA},$ $\overline{\text{FORCEON}} = \text{GND},$ $\overline{\text{FORCEOFF}} = V_{\text{CC}}$			0.4	V

† All typical values are at  $V_{\text{CC}} = 3.3 \text{ V}$  or  $V_{\text{CC}} = 5 \text{ V}$  and  $T_{\text{A}} = 25^{\circ}\text{C}$ .

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 4)**

PARAMETER		MIN	TYP†	MAX	UNIT
$t_{\text{VALID}}$	Propagation delay time, low- to high-level output		1		$\mu\text{s}$
$t_{\text{INVALID}}$	Propagation delay time, high- to low-level output		30		$\mu\text{s}$
$t_{\text{en}}$	Receiver and driver output enable time		100		$\mu\text{s}$

† All typical values are at  $V_{\text{CC}} = 3.3 \text{ V}$  or  $V_{\text{CC}} = 5 \text{ V}$  and  $T_{\text{A}} = 25^{\circ}\text{C}$ .

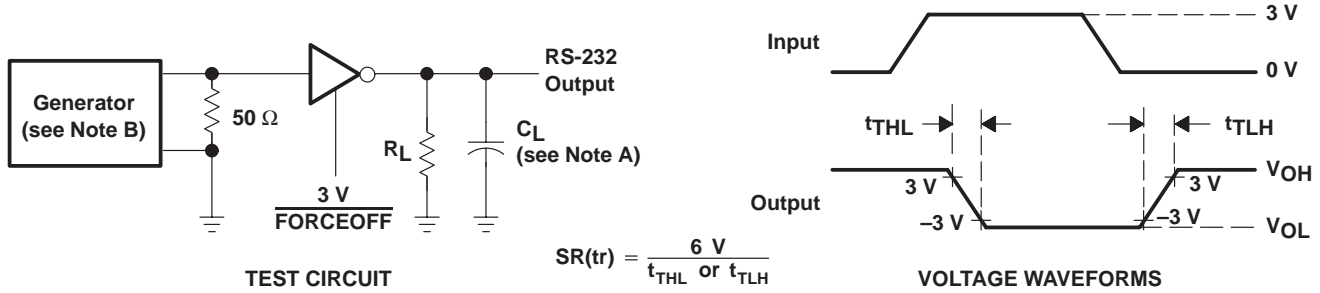
**PRODUCT PREVIEW**

# MAX3238

## 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER

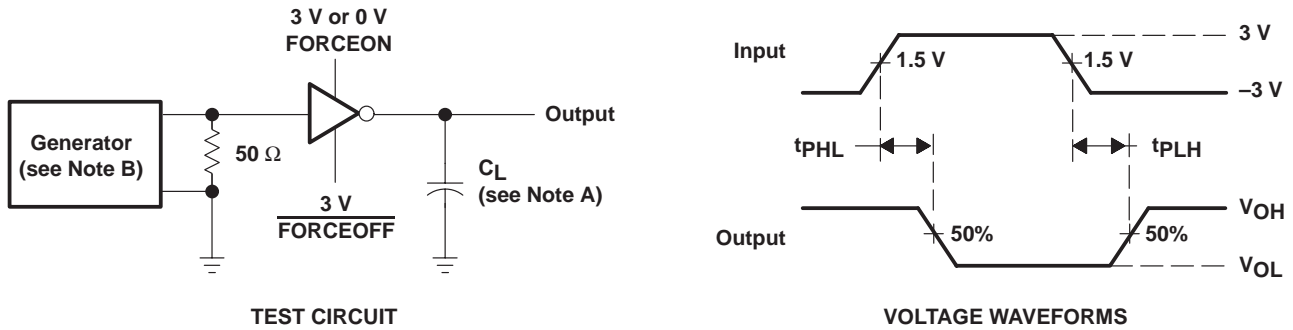
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### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10 \text{ ns}$ ,  $t_f \leq 10 \text{ ns}$ .

Figure 1. Driver Slew Rate



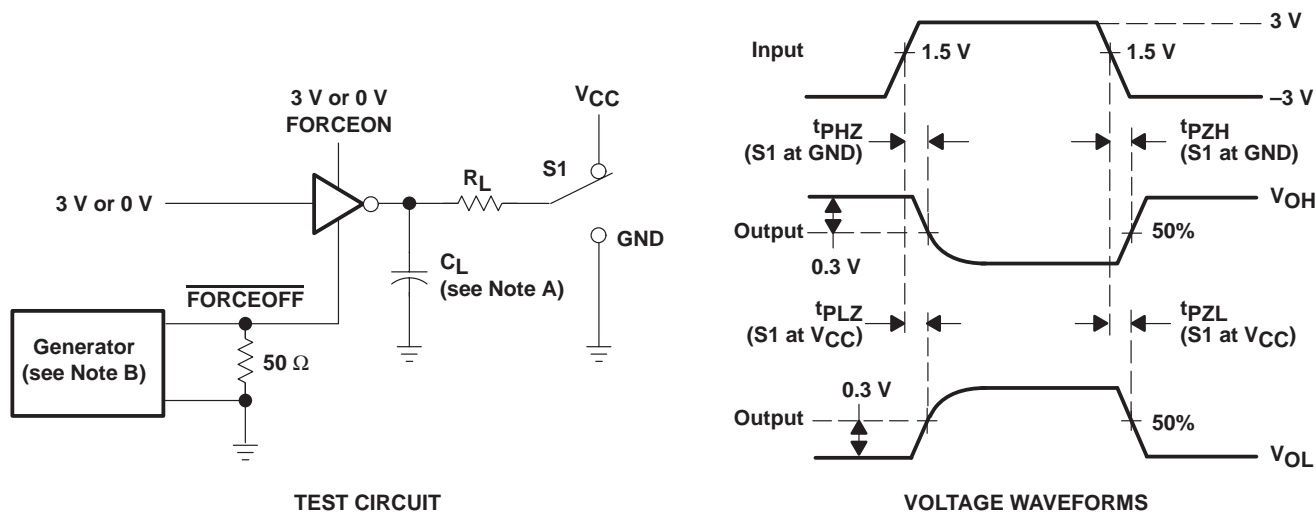
NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics: PRR = 512 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10 \text{ ns}$ ,  $t_f \leq 10 \text{ ns}$ .

Figure 2. Receiver Propagation Delay Times

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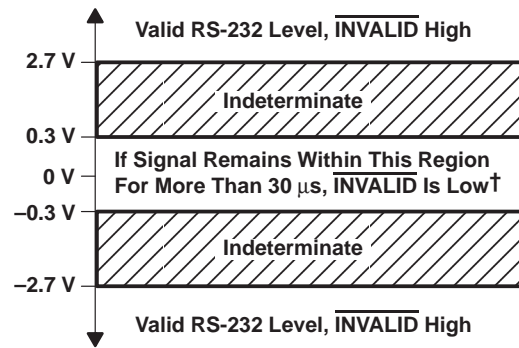
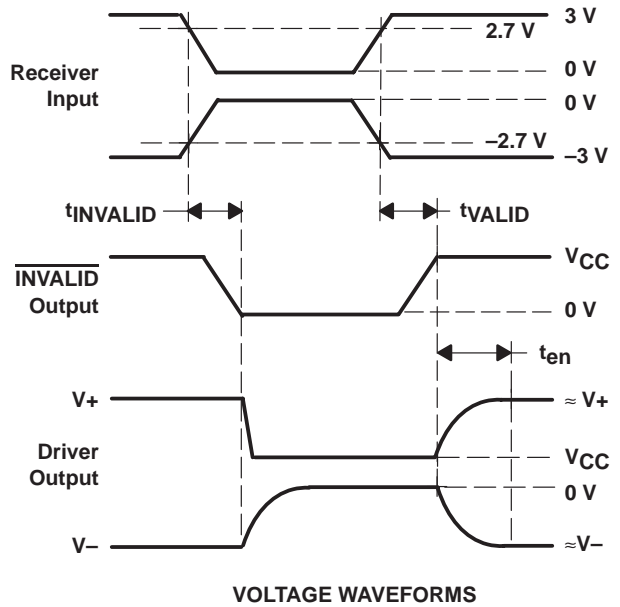
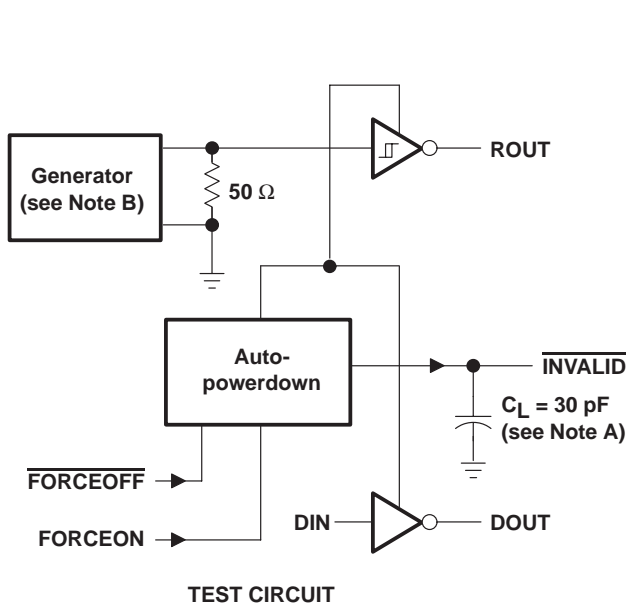
PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics: PRR = 512 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.  
 C.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 D.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .

Figure 3. Receiver Enable and Disable Times

PARAMETER MEASUREMENT INFORMATION



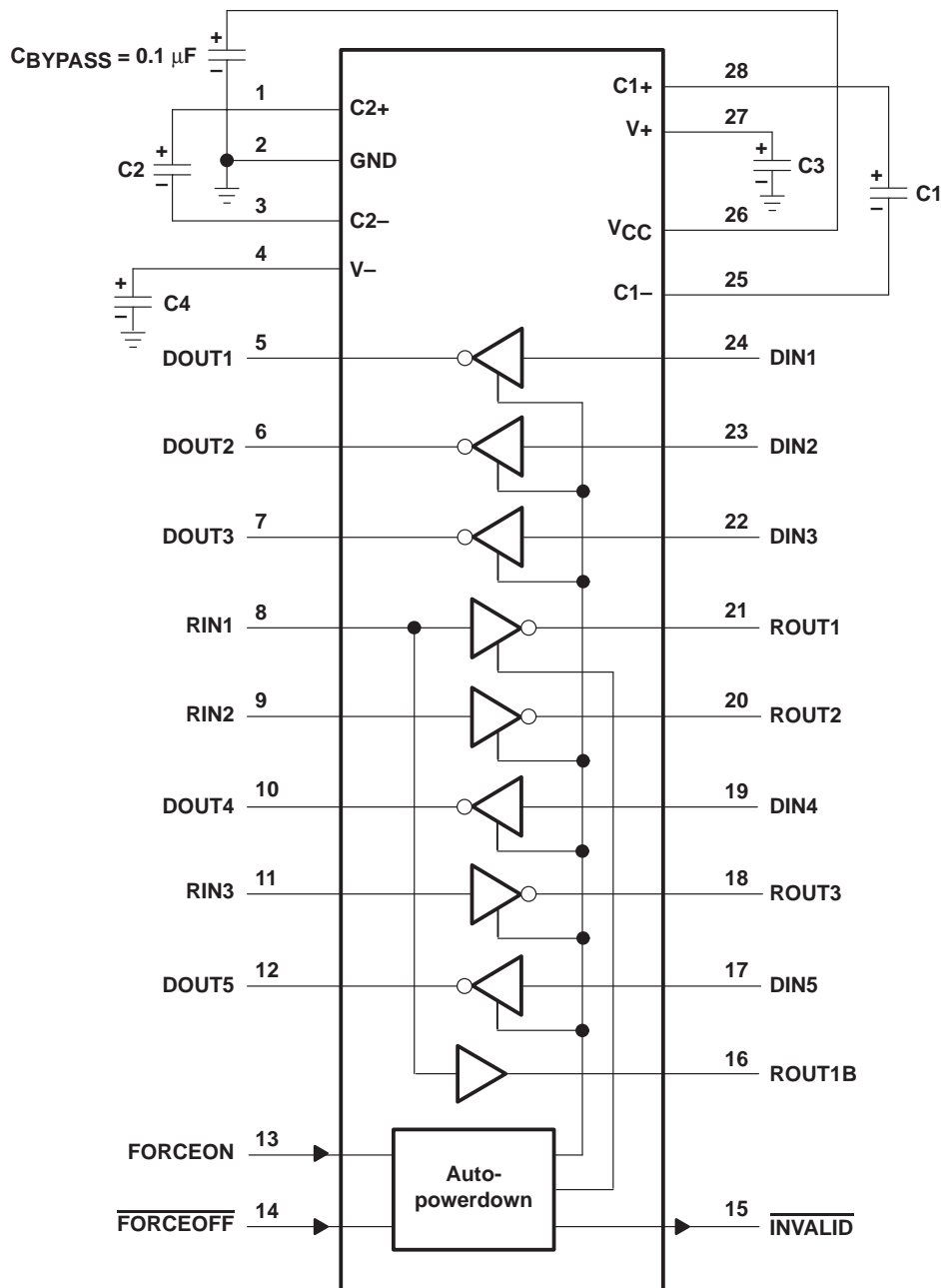
† Auto-powerdown disables drivers and reduces supply current to 1  $\mu$ A.

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The pulse generator has the following characteristics: PRR = 512 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

Figure 4.  $\overline{\text{INVALID}}$  Propagation Delay Times and Driver Enabling Time

PRODUCT PREVIEW

APPLICATION INFORMATION



V<sub>CC</sub> vs CAPACITOR VALUES

V <sub>CC</sub>	C1	C2, C3, and C4
3.3 V ± 0.3 V	0.1 μF	0.1 μF
5 V ± 0.5 V	0.047 μF	0.33 μF
3 V to 5.5 V	0.1 μF	0.47 μF

Figure 5. Typical Operating Circuit and Capacitor Values

PRODUCT PREVIEW

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